

MODEL NO. : <u>TM022HDH06-00</u>

ISSUED DATE: 2008-11-13

VERSION : Ver 1.0

■ Preliminary Specification ☐ Final Product Specification

Customer:			
CHSTOME	8		

Approved by	Notes

SHANGHAI TIANMA Confirmed:

Prepared by	Checked by	Approved by		
翔华208.11.13	超级	7 B 0811/17		

This technical specification is subjected to change without notice



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Record of Revision

Rev	Issued Date	Description	Editor
1.0	2008-11-13	Preliminary Specification Release	Xinhua Kang



1 General Specifications

	Feature	Spec	
	Size	2.2 inch	
	Resolution	240(RGB) x 320	
	Interface	CPU 16 bits	
	Color Depth	262K	
	Technology Type	a-Si	
Display Spec.	Pixel Pitch (mm)	0.1395X0.1395	
	Pixel Configuration	R.G.B. Vertical Stripe	
	Display Mode	TM with Normally White	
	Surface Treatment(Up Polarizer)	Clear Type(3H)	
	Viewing Direction	6 o'clock	
	Gray Scale Inversion Direction	12 o'clock	
	LCM (W x H x D) (mm)	40.10x55.20x2.35	
Manhaniaal	Active Area(mm)	33.48x44.64	
Mechanical Characteristics	With /Without TSP	Without TSP	
	Weight (g)	TBD	
	LED Numbers	4 LEDs	
Electronic	Driver IC	ILI9325	

Note 1: Viewing direction for best image quality is different from TFT definition, there is a 180 degree shift.

Note 2: Requirements on Environmental Protection: RoHS

Note 3: LCM weight tolerance: +/- 5%



2 Input/Output Terminals

2.1 TFT LCD Panel

No	SYMBOL	I/O	Description	Remark				
1	DB0	I	Data bus					
2	DB1	I	Data bus					
3	DB2	I	Data bus					
4	DB3	I	Data bus					
5	GND	Р	ver					
6	VCC	Р	Power					
7	/CS	I	Chip select					
8	RS	I	Register select					
9	/WR	I	Write					
10	/RD	I	Read					
11	IM0	I	Mode select					
12	NC		No connection					
13	NC		No connection					
14	NC		No connection					
15	NC		No connection					
16	LED_A	Р	LED power					
17	LED_K1	Р	LED power					
18	LED_K2	Р	LED power					
19	LED_K3	Р	LED power					
20	LED_K4	Р	LED power					
21	NC		No connection					
22	DB4	I	Data bus					
23	DB8	I	Data bus					
24	DB9	I	Data bus					
25	DB10	I	Data bus					
26	DB11	I	Data bus					
27	DB12	I	Data bus					
28	DB13	I	Data bus					
29	DB14	I	Data bus					
30	DB15	I	Data bus					
31	/RESET	I	Reset					
32	VCI	Р	Power					
33	VCC	Р	Power					
34	GND	Р	Power					
35	DB5	ı	Data bus					
36	DB6	ı	Data bus					
37	DB7	I	Data bus					

Note 1: I/O definition:

I-----Input O---Output P----Power(Ground) NC---No connection



3 Absolute Maximum Ratings

3.1 Driving TFT LCD Panel

 $Ta = 25^{\circ}C$

Item	Symbol	Min.	Max.	Unit	Remark
Supply Voltage	VCI/ VCC	-0.3	4.6	V	
Input Signal Voltage	DB0~DB15,/CS,RS,/WR,/RD, IM0,/RESET	-0.3	VCC +0.3	V	
Back Light Forward Current	I _{LED}		25	mA	For each LED
Operating Temperature	T_{OPR}	-20	70	$^{\circ}\!\mathbb{C}$	
Storage Temperature	T _{STG}	-30	80	$^{\circ}\!\mathbb{C}$	

4 Electrical Characteristics

4.1 Driving TFT LCD Panel

GND=0V, Ta=25℃

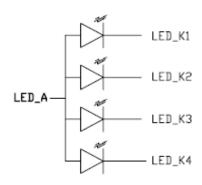
Item		Symbol	Min.	Тур.	Max.	Unit	Remark
Logic Supp	ly Voltage	VCC	1.65	2.8/1.8	3.3	V	
Analog supp	oly voltage	VCI	2.5	2.8	3.3	V	
Input Signal	Low Level	VIL	0		0.2xVCC	٧	DB0~DB15,/CS,RS,
Voltage	High Level	VIH	0.8xVCC		VCC	V	/WR,/RD, IM0,/RESET
Output Signal Low Level		Vol	-0.3		0.3xVCC	V	
Voltage	High Level	Vон	0.7xVCC		VCC	V	
,		Black Mode (60Hz)		TBD		mW	Frame rate 60Hz, VCC=2.8V, VCI=2.8V
(Panel+ LSI) Power Consumption		8 Color Mode	1	TBD	1	uW	
		Sleeping Mode		TBD	1	uW	

4.2 **Driving Backlight**

Ta=25°C

Item	Symbol	Min.	Тур.	Max.	Unit	Remark
Forward Current	I _F	1	72	100	mA	4150-
Forward Voltage	V_{F}		3.2	3.5	٧	4 LEDs (in parallel)
Power Consumption	W_{BL}	-	230	350	mW	(iii paraiiei)

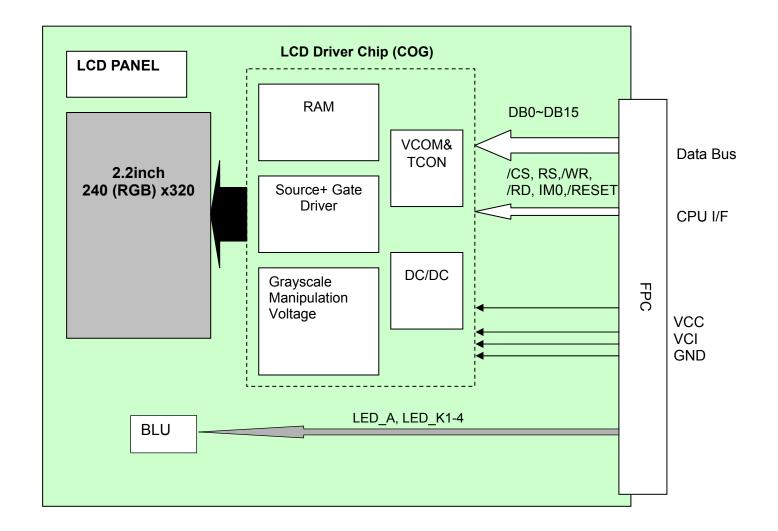
Note1: Figure below shows the connection of backlight LED.



Note 2: One LED : I_F =18 mA, V_F =3.2V Note 3: The life of LED : 20,000 hours



4.3 Block Diagram



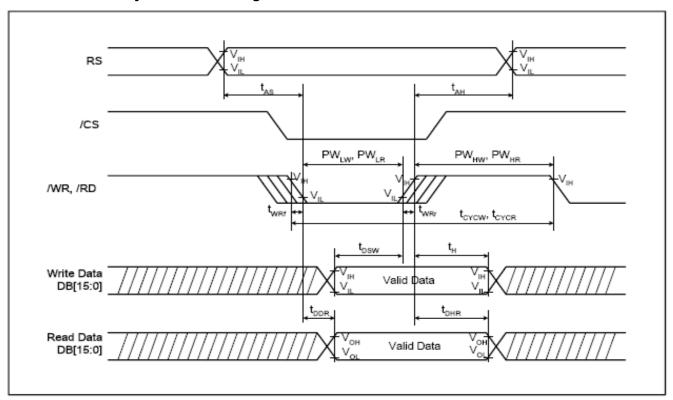
5 Timing Chart

5.1 **I80 System Timing Parameter**

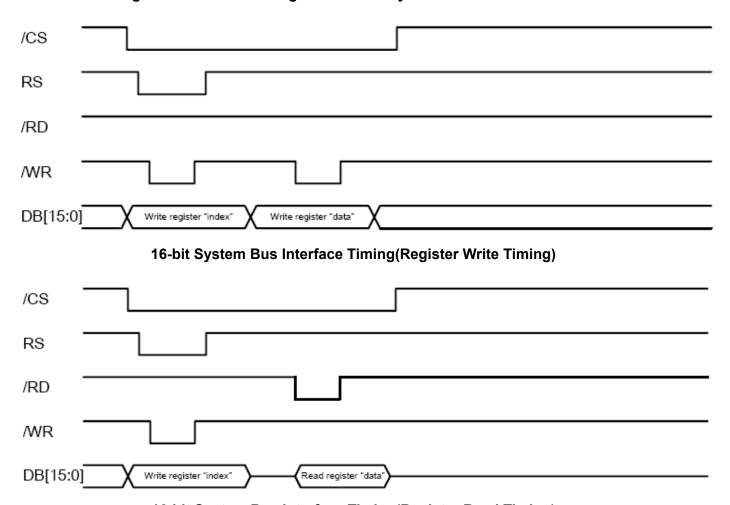
Normal Write Mode (VCC=2.5~3.3V)

	Item			Min.	Тур.	Max.	Test Condition
Bus cycle time	Write	t _{CYCW}	ns	100	-	-	
Due eyele illie	Read	t _{CYCR}	ns	300	-	-	
Write low-level puls	se width	PW _{LW}	ns	50	-	500	
Write high-level pu	lse width	PW _{HW}	ns	50	-	-	
Read low-level puls	se width	PW _{LR}	ns	150	-	-	
Read high-level pulse width		PW _{HR}	ns	150	-	-	
Write / Read rise / fall time		t _{WRr} /t _{WRf}	ns	-	-	25	
Setup time	Write (RS to /CS, E/WR)	tas	t _{AS} ns	10	-	-	
Cottap time	Read (RS to /CS, RW/RD)			5	-	-	
Address hold time		t _{AH}	ns	5	-	-	
Write data set up time		t _{DSW}	ns	10	-	-	
Write data hold time		t _H	ns	15	-	-	
Read data delay time		t _{DDR}	ns	-	-	100	
Read data hold tim	е	t _{DHR}	ns	5	-	-	

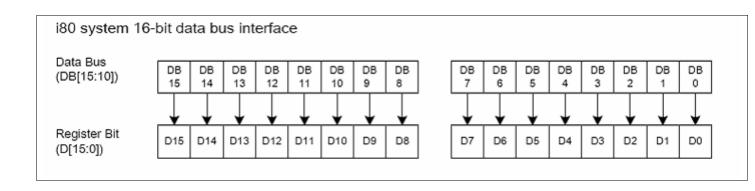
5.1.1 I80 System Bus Timing



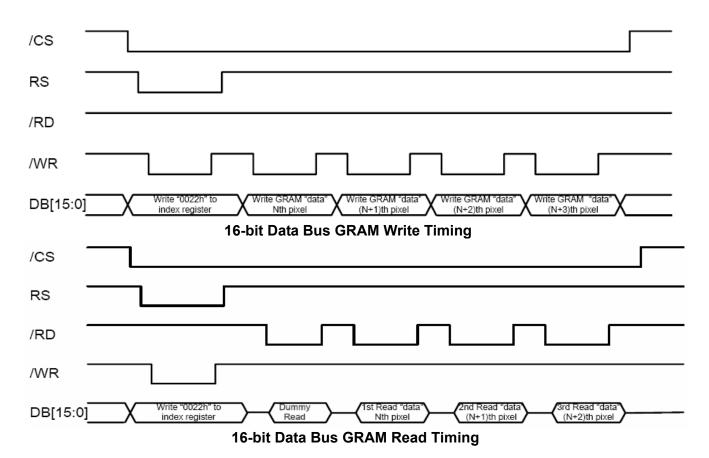
5.1.2 Register write /read timing in I80 series system



16-bit System Bus Interface Timing(Register Read Timing)



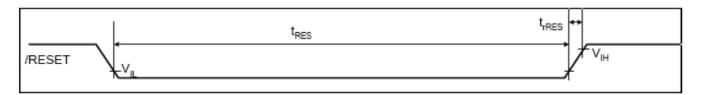
5.1.3 GRAM write/read timing in I80 series system



TRI DFM 16-bit MPU System Interface Data Format system 16-bit interface (1 transfers/pixel) 65,536 colors 1st Transfer 0 80-system 16-bit interface (2 transfers/pixel) 262,144 colors 1st Transfer 2nd Transfer 0 1 DB DB 7 80-system 16-bit interface (2 transfers/pixel) 262,144 colors 2nd Transfer 1st Transfer 1 1 DB 0 DB 14 DB 10 DB 5

5.1.4 Reset Timing Characteristics

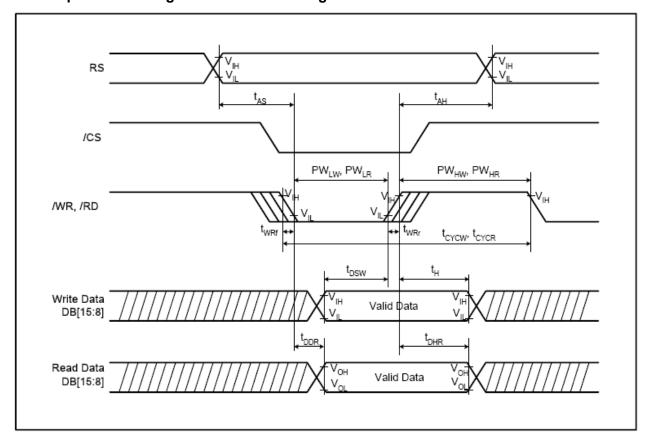
Item	Symbol	Unit	Min.	Тур.	Max.
Reset low-level width	t _{RES}	ms	1	-	-
Reset rise time	t _{rRES}	μs	-	-	10



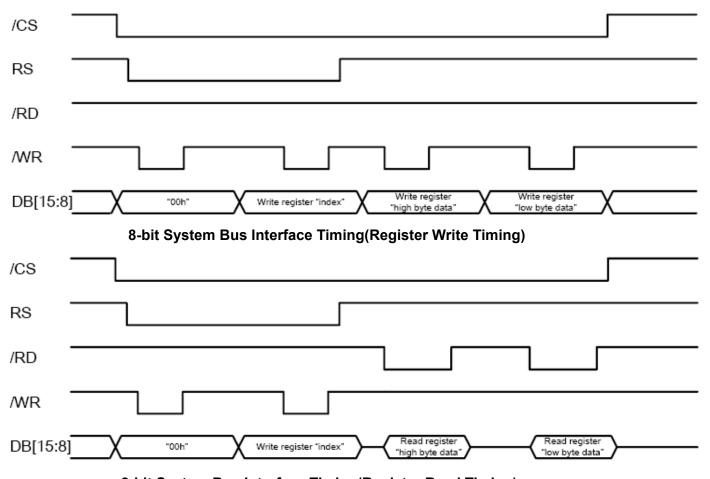
5.1.5 IMO 16-bit Selection Pin Characteristics

IM0	Interface	DB Pin
1	i80-parallel 8bit interface	DB[15~8]
0	i80-parallel 16bit interface	DB[15~0]

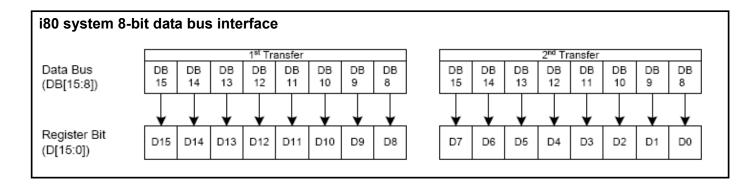
180-parallel 8bit register write/read timing



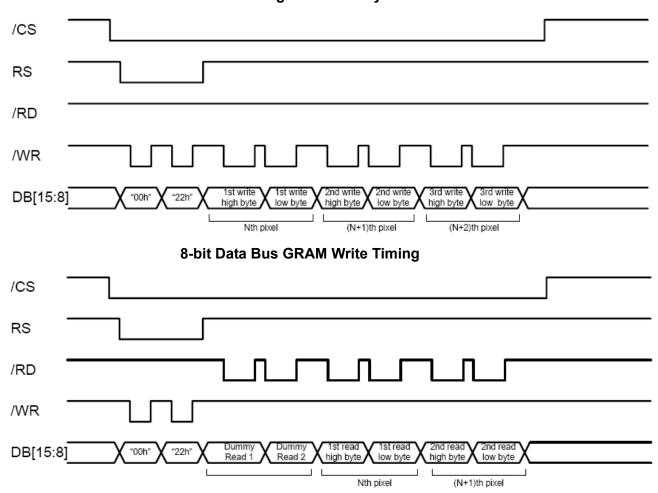
5.1.5.1 Register write/read timing in I80 8-bit system



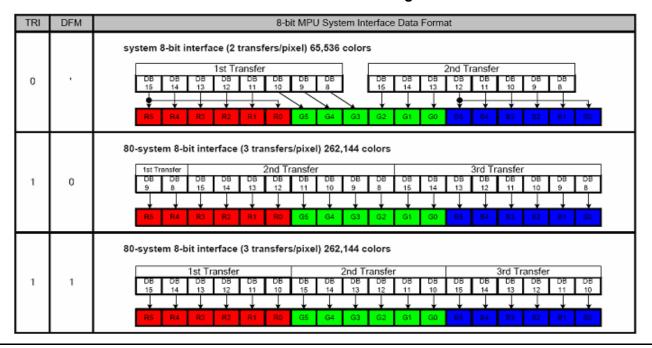
8-bit System Bus Interface Timing(Register Read Timing)



5.1.5.2 GRAM write/read timing in I80 8-bit system



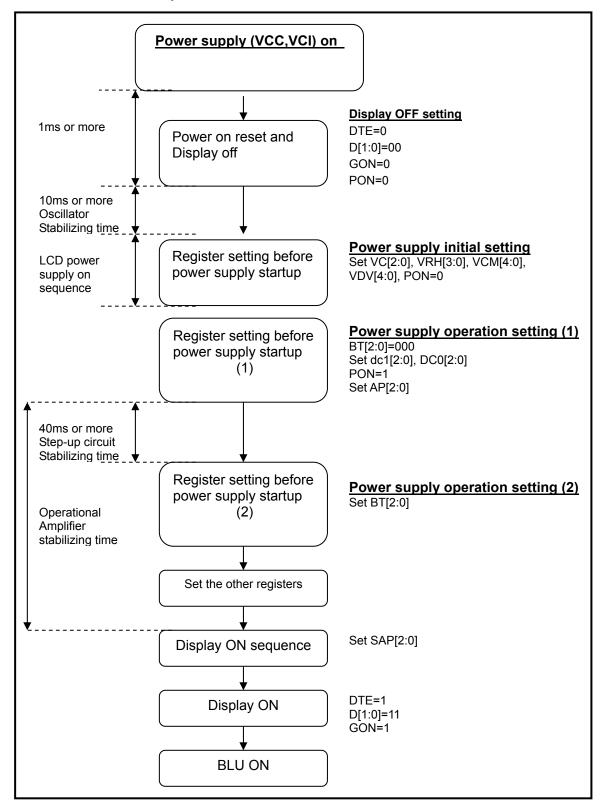
8-bit Data Bus GRAM Read Timing



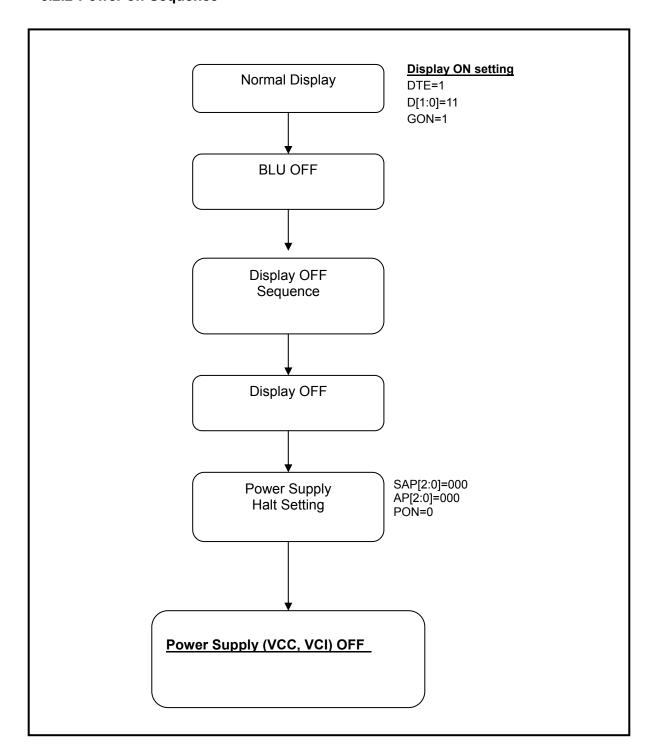


5.2 Power On/Off sequence

5.2.1 Power on Sequence



5.2.2 Power off Sequence



6 Optical Characteristics

6.1 Optical Specification

Ta=25°C

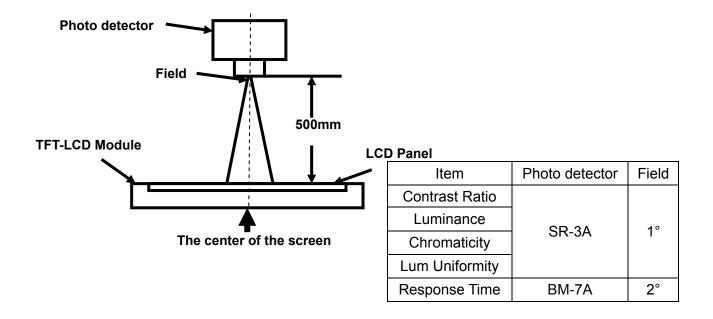
Item		Symbol	Condition	Min.	Тур.	Max.	Unit	Remark
View Angles		θТ	- CR≧10	50	60	-	Degree	Note 2
		θВ		30	40	-		
		θL		50	60	-		
		θR		50	60	-		
Contrast Ratio		CR	θ=0°	200	350	-		Note1 Note3
Response Time		T _{ON}	25℃	-	25	40	ms	Note1
		T _{OFF}						Note4
	White	х	Backlight is on	-	TBD	-	Note5 Note1	
		У		-	TBD	-		Note5, Note1
	Red	х		-	TBD	-		
Chromaticity		у		-	TBD	-		
Chilomaticity	Green	х		-	TBD	-		
		у		-	TBD	-		
	Blue	х		-	TBD	-		
		у		-	TBD	-		
Uniformity		U		75	80	-	%	Note1 Note6
NTSC				-	62	-	%	Note 5
Luminance		L		170	220	-	cd/m ²	Note1 Note7

Test Conditions:

- 1. V_F =3.2V, I_F=72mA(Backlight current), the ambient temperature is 25℃.
- 2. The test systems refer to Note 1 and Note 2.

Note 1: Definition of optical measurement system.

The optical characteristics should be measured in dark room. After 5 minutes operation, the optical properties are measured at the center point of the LCD screen. All input terminals LCD panel must be ground when measuring the center area of the panel.



Note 2: Definition of viewing angle range and measurement system.

viewing angle is measured at the center point of the LCD by CONOSCOPE(ergo-80).

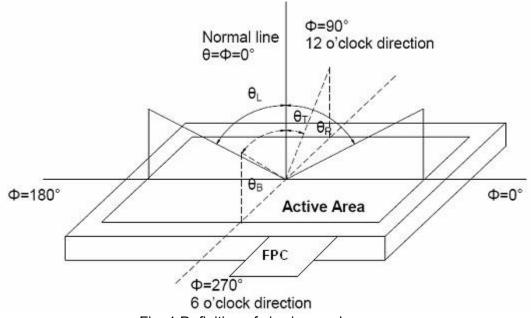


Fig. 1 Definition of viewing angle

Note 3: Definition of contrast ratio

Contrast ratio (CR) = Luminance measured when LCD is on the "White" state

Luminance measured when LCD is on the "Black" state

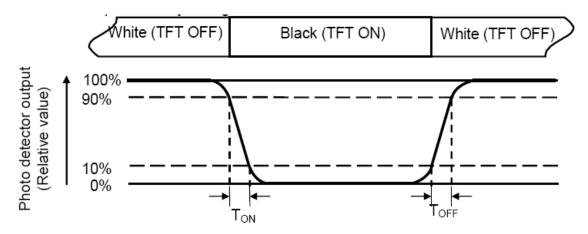
"White state ":The state is that the LCD should be driven by Vwhite.

"Black state": The state is that the LCD should be driven by Vblack.

Vwhite: To be determined Vblack: To be determined.

Note 4: Definition of Response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (T_{ON}) is the time between photo detector output intensity changed from 90% to 10%. And fall time (T_{OFF}) is the time between photo detector output intensity changed from 10% to 90%.



Note 5: Definition of color chromaticity (CIE1931)

Color coordinates measured at center point of LCD.

Note 6: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (Refer Fig. 2). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity(U) = Lmin/Lmax

L----- Active area length W----- Active area width

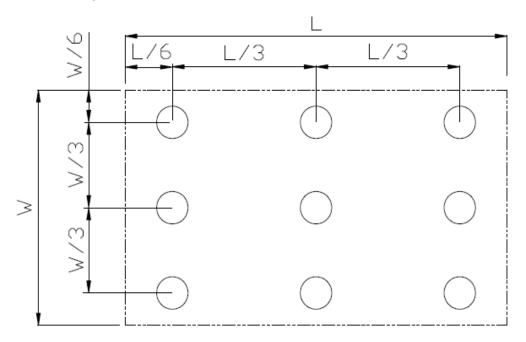


Fig. 2 Definition of uniformity

Lmax: The measured maximum luminance of all measurement position.

Lmin: The measured minimum luminance of all measurement position.

Note 7: Definition of Luminance:

Measure the luminance of white state at center point.



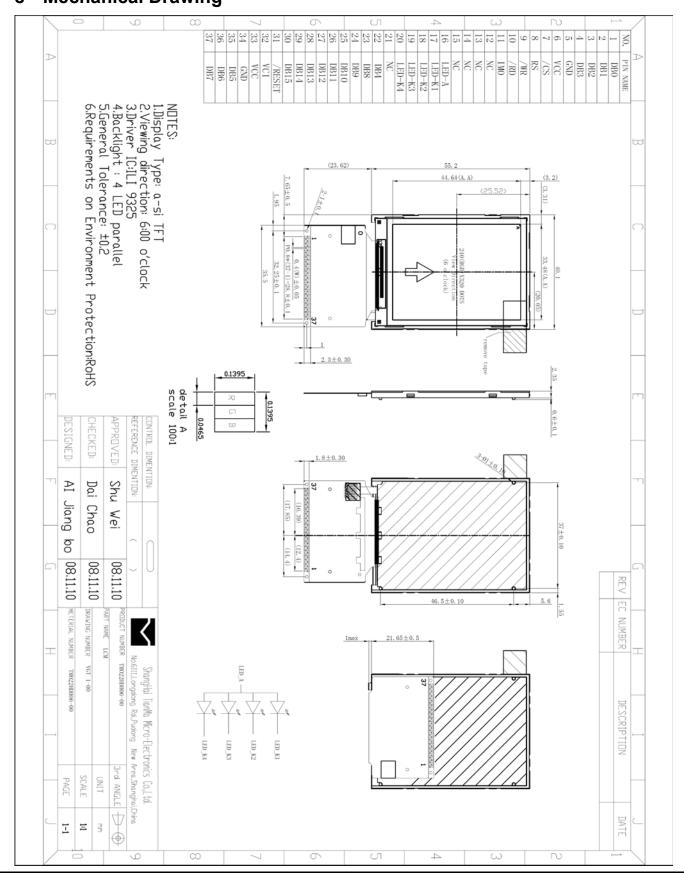
7 Environmental / Reliability Tests

No	Test Item	Condition	Remarks		
1	High Temperature Operation	Ts=+70℃, 240hrs	Note1 IEC60068-2-2,GB2423.2—89		
2	Low Temperature Operation	Ta=-20℃, 240hrs	IEC60068-2-1 GB2423.1—89		
3	High Temperature Storage	Ta=+80℃, 240hrs	IEC60068-2-2, GB2423.2—89		
4	Low Temperature Storage	Ta=-30℃, 240hrs	IEC60068-2-1 GB2423.1—89		
5	High Temperature & High Humidity Storage	Ta=+60℃, 90% RH 240 hours	Note2 IEC60068-2-3, GB/T2423.3—2006		
6	Thermal Shock (Non-operation)	-30°C 30 min~+80°C 30 min, Change time:5min, 20 Cycles	Start with cold temperature, End with high temperature, IEC60068-2-14,GB2423.22—87		
7	Electro Static Discharge (Operation)	C=150pF, R=330 Ω , 5points/panel Air:±8KV, 5times; Contact:±4KV, 5 times; (Environment: 15 $^{\circ}$ C \sim 35 $^{\circ}$ C, 30% \sim 60%, 86Kpa \sim 106Kpa)	IEC61000-4-2 GB/T17626.2—1998		
8	Vibration (Non-operation)	Frequency range:10~55Hz, Stroke:1.5mm Sweep:10Hz~55Hz~10Hz 2 hours for each direction of X.Y.Z. (6 hours for total)(Package condition)	IEC60068-2-6 GB/T2423.10—1995		
9	Shock (Non-operation)	60G 6ms, ±X,±Y,±Z 3times, for each direction	IEC60068-2-27 GB/T2423.5—1995		
10	Package Drop Test	Height:80 cm, 1 corner, 3 edges, 6 surfaces	IEC60068-2-32 GB/T2423.8—1995		

Note1: Ts is the temperature of panel's surface.

Note2: Ta is the ambient temperature of sample.

Mechanical Drawing





TM022HDH06-00 V1.0



TBD

10 Precautions for Use of LCD Modules

- 10.1 Handling Precautions
- 10.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 10.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 10.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 10.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 10.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol
 - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- 10.1.6 Do not attempt to disassemble the LCD Module.
- 10.1.7 If the logic circuit power is off, do not apply the input signals.
- 10.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
- 10.1.8.1 Be sure to ground the body when handling the LCD Modules.
- 10.1.8.2 Tools required for assembly, such as soldering irons, must be properly ground.
- 10.1.8.3 To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
- 10.1.8.4 The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.
- 10.2 Storage precautions
- 10.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 10.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature : 0°C ~ 40°C Relatively humidity: ≤80%

- 10.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.
- 10.3 Transportation Precautions:

The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.